Updates of LDC Tracking Package

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- Modifications of TPCDigiProcessor : treatment of hit patterns with equdistant distance between hits (Steve Aplin)
- Modifications of VTXDigiProcessor : smearing of hits along ladder planes (Clare Lynch)
- Implementation of new SIT (Sit01, Sit02) Mokka drivers : substitution of heavy-weight Si (Si_8.22) by support+sensitive layer structure (Hengne Li, Valery Saveliev)
- Changes to MaterialDB processor to account for changes in SIT and FTD drivers (AR)
- Implementation of correct GEAR steerings for the new SIT driver (Andreas Moll, AR)



New SIT Drivers

- Sit00 (Old version)
 - > Heavy-weight Si ($g=8.72 \text{ g/cm}^2$), layer thickness=0.3mm
- Sit01 (implementation by Hengne Li)
 - Si & Beryllium support; Si thickness=0.2mm; support thickness=1mm
- Sit02 (implemented by Valery Saveliev)
 - ➢ Si & Graphite support; Si thickness=0.2mm; support thickness=1mm
- \Rightarrow Modification of Gear steering (changes in Sit01/02 Mokka drivers)
- \Rightarrow Modification of MaterialDB processor





cparameter name="SITLayerRadius" type="DoubleVec" value="160 270" />
</detector>

Summary

- Changes have been implemented in Mokka drivers and LDCTracking package to account for a more realistic configuration of tracking devices
- First look revealed no major problems, code successfully runs with the new digitizers material shapes on LCIO files produced with LDC01_05Sc model
- Tracking performance studies for LDC01_05Sc and LDCPrime_01Sc are ongoing
- NB : all changes in tracker Mokka drivers or tracker digitizers should be communicated to MPI group ⇒ coherent propagation of changes to the LDCTracking package